

ST17H65BF

Embed Find My network ADK 1.0

Key Features

- ARM[®] Cortex[™]-M0 32-bit processor
- Memory
 - > 512KByte-2MByte in-system flash memory
 - 64KB SRAM, all programmable retention in sleep mode
 - 4-way instruction cache with 8KB Cache RAM
 - > 96KB ROM
 - > 256bit efuse
- 20 general purpose I/O pins
 - GPIO status retention in off/sleep mode
 - configurable as serial interface and programmable IO MUX function mapping
 - > All pins can be configured for wake-up
 - > All pins for triggering interrupt
 - 3 quadrature decoder(QDEC)
 - > 6-channel PWM
 - > 2-channel PDM/I2C/SPI/UART
 - > 4-channel DMA
- DMIC/AMIC with microphone bias
- · 8-channel 12bit ADC with low noise voice PGA
- 6-channel 24bit timer, one watchdog timer
- Real timer counter (RTC)
- Power, clock, reset controller
- Flexible power management
 - Operating Voltage range 1.8V to 3.6V
 - > Embedded buck DC-DC and LDOs
 - > Battery monitor
- Power consumption
 - > 0.3μA @ OFF Mode(IO wake up only)
 - > 1μA @ Sleep Mode with 32KHz RTC
 - 4uA @ Sleep Mode with 32KHz RTC and all SRAM retention
 - > Receive mode: 4mA @3.3V power supply
 - Transmit mode: 4.7mA(0dBm output power)@3.3V power supply
 - > MCU: <60uA/MHz
- Secure Vault
 - > ECC-224,ECC-256
 - ➤ HMAC-SHA256

- > AES128, AES256
- Public key cryptography
- > TRNG
- RC oscillator hardware calibrations
 - Internal High/Low frequency RC osc
 - ▶ 32KHz RC osc for RTC with +/-500ppm accuracy
 - > 32MHz RC osc for HCLK with 3% accuracy
- High Speed Throughput
 - > Support BLE 2Mbps Protocol
 - > Support Data Length Extension
 - Throughput up to 1.6Mbps(DLE+2Mbps)
- BLE 5.4 feature
- AoA/AoD Direction Finding
- Support SIG-Mesh Multi-Feature
 - Friend Node
 - > Low Power Node
 - Proxy Node
 - > Relay Node
- Apple Findmy
 - Findmy pairing key roll 600ms@16MHZ
 - > Findmy separate key roll 2ua/15min
 - > Findmy Nearby 18ua@2s adv period
 - Findmy separate 18ua@2s adv period
- 2.4 GHz transceiver
 - > Compliant to Bluetooth 5.4
 - > Sensitivity:
 - -97dBm@BLE 1Mbps data rate
 - > TX Power -20 to +10dBm in 3dB steps
 - Single-pin antenna: no RF matching or RX/TX switching required
 - RSSI (1dB resolution)
 - Antenna array and optional off-chip RF PA/LNA control interface
- AES-128 encryption hardware
- Link layer hardware
 - Automatic packet assembly
 - > Automatic packet detection and validation
 - > Auto Re-transmit
 - Auto ACK
 - Hardware Address Matching

> Random number generator

• Operating temperature: -40 °C~125°C

RoHS Package: QFN32(4mm x 4mm)

Applications: FindMyNetwork(IOS), Wearables,

beacons, Home and building, Health and medical, Industrial and manufacturing, Data transmission, PC/mobile/TV peripherals, Internet of things (IoT)

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1 Introduction

ST17H65BF is a System on Chip (SoC) for Bluetooth® low energy applications. It has ARM® Cortex™-M0 32-bit processer with 64K retention SRAM, 512KB-2MB flash, 96KB ROM, 256bit efuse, and an ultra-low power, high performance, multi-mode radio. Also, ST17H6x can support BLE with security, application and over-the-air download update. Serial peripheral IO and integrated application IP enables customer product to be built with minimum bill-of-material (BOM) cost.

2 Pin Assignments and Functions

This section describes the pin assignment and the pin functions for the package type of QFN32.

2.1 Pin Assignment(QFN32)

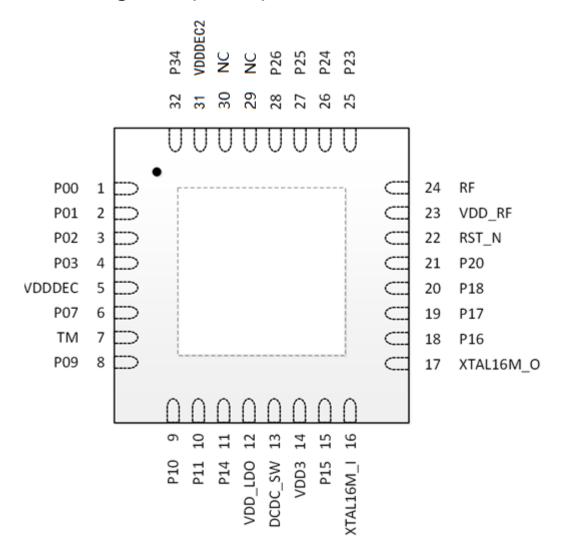


Figure 1: Pin assignment – ST17H65BF QFN32 package



2.2 Pin Functions

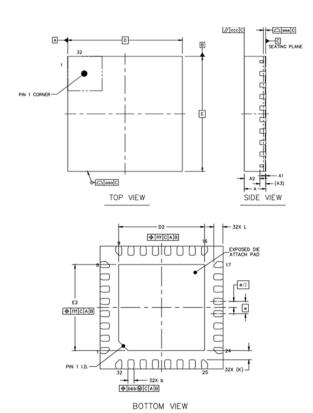
Pin	Pin name	Description		
1	PO	GPIO 0		
2	P1	GPIO 1		
3	P2	GPIO 2		
4	P3	GPIO 3		
5				
6	VDDDEC	1.2V decoupling pin		
7	P7	GPIO 7		
	TM	test mode enable		
8	P9	GPIO 9		
9	P10	GPIO 10		
10	P11/AIO_0	GPIO 11/ADC input 0		
11	P14/AIO_3	GPIO 14/ADC input 3		
12	VDD_LDO	Internal LDO power supply/DCDC feedback		
13	DCDC_SW	DCDC output		
14	VDD3	3.3V power supply		
15	P15/AIO_4	GPIO 15/ADC input 4/ micbias output		
16	XTAL16M_I	16MHz crystal input		
17	XTAL16M_O	16MHz crystal output		
18	XTAL32K_I	32.768KHz crystal input		
19	XTAL32K_O	32.768KHz crystal output		
20	P18/AIO_7	GPIO 18/ADC input 7/ PGA negative input		
21	P20/AIO_9	GPIO 20/ADC input 9/ PGA positive input		
22	RST_N	reset, active low		
23	VDD_RF	power supply decoupling for RF transceiver		
24	RF	RF antenna		
25	P23/AIO_1	GPIO 23/ADC input 1/micbias reference		
26	P24/AIO_2	GPIO 24/ADC input 2		
27	P25/AIO_8	GPIO 25/ADC input 8		
28	P26	GPIO 26		
29	NC			
30	NC			
31	VDDDEC2			
32	P34	GPIO 34		
		*Note: All price support 104/450kg and up 150kg and decree		

*Note: All gpio support $1M/150k\Omega$ pull up, $150k\Omega$ pull down.

Table 1: Pin functions of ST17H6x QFN32 package



3 Package dimensions



		SYMBOL	MIN	NOM	MAX
TOTAL THICKNESS	A	0.7	0.75	0.8	
STAND OFF	A1	0	0.02	0.05	
MOLD THICKNESS	A2		0.55		
L/F THICKNESS	A3	0.203 REF			
LEAD WDTH	b	0.15	0.2	0.25	
BODY SIZE	X	D	4 BSC		
BOUT SIZE	Y	Ε	4 BSC		
LEAD PITCH	e	0.4 BSC			
EP SIZE	×	D2	2.7	2.8	2.9
EP SIZE	Y	E2	2.7	2.8	2.9
LEAD LENGTH	L	0.2	0.3	0.4	
LEAD TIP TO EXPOSED	к	0.3 REF			
PACKAGE EDGE TOLERA	000	0.1			
MOLD FLATNESS	ccc	0.1			
COPLANARITY	eee	0.08			
LEAD OFFSET	bbb	0.07			
EXPOSED PAD OFFSET	fff	0.1			

Figure 2: QFN32 package dimensions

Note: dimensions are in mm, angels are in degree.